

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>DAVID SHAU CHEW WANG</td> <td>05/27/2013</td> </tr> <tr> <td>WEN FENG LEE</td> <td>05/27/2013</td> </tr> <tr> <td>EN TIEN YANG</td> <td>05/24/2013</td> </tr> <tr> <td>CHUN TENG TSENG</td> <td>05/27/2013</td> </tr> <tr> <td>YI AN SHA</td> <td>05/24/2013</td> </tr> </tbody> </table>		Name	Execution Date	DAVID SHAU CHEW WANG	05/27/2013	WEN FENG LEE	05/27/2013	EN TIEN YANG	05/24/2013	CHUN TENG TSENG	05/27/2013	YI AN SHA	05/24/2013
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RECEIVING PARTY DATA													
Name:	POLYTRONICS TECHNOLOGY CORPORATION												
Street Address:	NO. 24-1, INDUSTRY E. RD. 4TH, HSINCHU SCIENCE PARK												
City:	HSINCHU												
State/Country:	TAIWAN												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13910916</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13910916								
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CORRESPONDENCE DATA													
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ATTORNEY DOCKET NUMBER:	2012014US (385-0104)												
NAME OF SUBMITTER:	ALEXIS SAENZ												
Signature:	/ ALEXIS SAENZ /												

Date:

06/05/2013

Total Attachments: 2

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**ASSIGNMENT**

**WHEREAS**, the undersigned inventor(s) (hereinafter individually and collectively referred to as "ASSIGNOR") has/have invented:

**SURFACE MOUNTABLE OVER-CURRENT PROTECTION DEVICE**

for which application for Letters Patent of the United States:

  X   has been executed on even date herewith;

       was executed on \_\_\_\_\_;

       was filed on \_\_\_\_\_ and assigned U.S. Application No. \_\_\_\_\_;

**AND WHEREAS**, POLYTRONICS TECHNOLOGY CORP., a corporation having a place of business at NO. 24-1, INDUSTRY E. RD. 4<sup>TH</sup>, HSINCHU SCIENCE PARK, HSINCHU, TAIWAN, R.O.C. (hereinafter "ASSIGNEE"), and successors, assigns, and legal representatives, is desirous of acquiring the entire right, title, and interest therein;

**AND WHEREAS**, a "formal application," as referred to herein, shall mean any provisional, nonprovisional, continuation, continuation in part, continued prosecution, substitute, renewal, extension, divisional, reissue, reexamination, foreign, Patent Cooperation Treaty (PCT) or other patent application, inventor's certificate, utility model, or like document;

**NOW, THEREFORE**, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNOR does hereby sell, assign and transfer unto ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in and to the aforesaid application, to the invention as described in the aforesaid application, and to any formal application which may be filed based in whole or in part on the aforesaid application, in the United States and all foreign countries, together with the right of priority under any international conventions, treaties and/or agreements to which the United States currently adheres and adheres to in the future, and hereby authorizes and requests the Commissioner of Patents to issue said Letters Patent to ASSIGNEE, for the sole use and benefit of ASSIGNEE, its successors, assigns, and legal representatives;

**AND ASSIGNOR** authorizes ASSIGNEE, its successors, assigns, and legal representatives, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of aforesaid application and/or otherwise take advantage of the provisions of any international convention, treaty and/or agreement;

**AND ASSIGNOR FURTHERMORE** authorizes ASSIGNEE, its successors, assigns, and legal representatives, or anyone it may properly designate, to insert in this instrument the filing date and/or serial number of said application when ascertained;

**AND ASSIGNOR AGREEING, FURTHERMORE**, upon request of ASSIGNEE, and without further remuneration, but at no expense to ASSIGNOR, that ASSIGNOR or ASSIGNOR'S executors or administrators will provide all reasonable assistance to obtain, maintain, and assert the fullest measure of legal protection that ASSIGNEE desires to obtain or assert for the invention, any related inventions, any formal application based thereon, and any resulting patents, including executing any and all papers desired by ASSIGNEE for the filing and granting of formal applications, the perfecting of title in ASSIGNEE, and in enforcing any rights in the invention, any related inventions, and any formal application or patent based thereon.

If any provision of this assignment is held by any court to be unenforceable, such provision shall be interpreted to accomplish the objectives of the original provision to the fullest extent allowed by law and the remainder of this assignment shall remain in full force and effect.

EXECUTED as of the date(s) written below by ASSIGNOR:

David Shau Chew Wang  
[INVENTOR 1 NAME] WANG, DAVID SHAU CHEW

Date: 5/27/2013

LEE, WEN FENG  
[INVENTOR 2 NAME] LEE, WEN FENG

Date: 2013, 5.27

Yang En Tien  
[INVENTOR 3 NAME] YANG, EN TIEN

Date: 2013. 5. 24

Tseng, Chun Teng  
[INVENTOR 4 NAME] TSENG, CHUN TENG

Date: 2013, 05, 27

Sha, Yi An  
[INVENTOR 5 NAME] SHA, YI AN

Date: 2013, 5, 24

\_\_\_\_\_  
[INVENTOR 6 NAME]

Date: \_\_\_\_\_